STEALTH[™] Dual Diode 30 A, 600 V

ISL9K1560G3

Description

The ISL9K1560G3 is a STEALTH dual diode optimized for low loss performance in high frequency hard switched applications. The STEALTH family exhibits low reverse recovery current (I_{RR}) and exceptionally soft recovery under typical operating conditions.

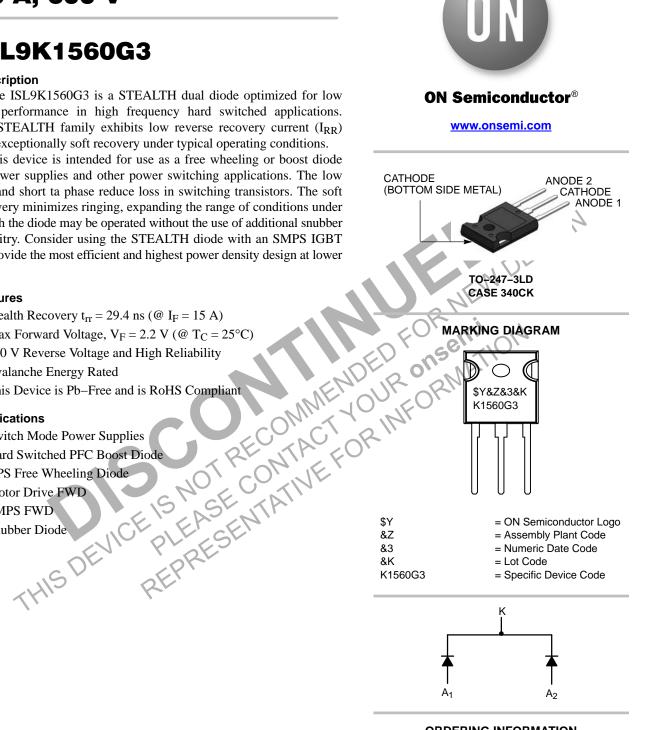
This device is intended for use as a free wheeling or boost diode in power supplies and other power switching applications. The low I_{RR} and short ta phase reduce loss in switching transistors. The soft recovery minimizes ringing, expanding the range of conditions under which the diode may be operated without the use of additional snubber circuitry. Consider using the STEALTH diode with an SMPS IGBT to provide the most efficient and highest power density design at lower cost.

Features

- Stealth Recovery $t_{rr} = 29.4$ ns (@ $I_F = 15$ A)
- Max Forward Voltage, $V_F = 2.2 \text{ V} (@ T_C = 25^{\circ}\text{C})$
- 600 V Reverse Voltage and High Reliability
- Avalanche Energy Rated
- This Device is Pb–Free and is RoHS Compliant

Applications

- Switch Mode Power Supplies
- Hard Switched PFC Boost Diode
- UPS Free Wheeling Diode
- Motor Drive FWD
- SMPS FWD
- Snubber Diode



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

DEVICE MAXIMUM RATINGS (per leg) (T_C = 25°C unless otherwise noted)

Parameter	Symbol	Ratings	Unit V	
Repetitive Peak Reverse Voltage	V _{RRM}	600		
Working Peak Reverse Voltage	V _{RWM}	600	V	
DC Blocking Voltage	V _R	600	V	
Average Rectified Forward Current (T _C = 145°C) Total Device Current (Both Legs)	I _{F(AV)}	15 30	A A	
Repetitive Peak Surge Current (20 kHz Square Wave)	I _{FRM}	30	А	
Nonrepetitive Peak Surge Current (Halfwave 1 Phase 60 Hz)	I _{FSM}	200	А	
Power Dissipation	PD	150	W	
Avalanche Energy (1 A, 40 mH)	E _{AVL}	20	mJ	
Operating and Storage Temperature Range	T _{J,} T _{STG}	-55 to +175	°C	
Maximum Temperature for Soldering Leads at 0.063 in (1.6 mm) from Case for 10 s Package Body for 10 s, See Techbrief TB334	T _L T _{PKG}	300 260	0° ℃	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. NE

PACKAGE MARKING AND ORDERING INFORMATION

ISL9K1560G3 K1560G3 TO-247-3L Tube N/A	30

THERMAL CHARACTERISTICS

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Thermal Resistance Junction to Case	R _{θJC}		-	-	1.0	°C/W
Thermal Resistance Junction to Ambient	R _{0JA}	TO-247	_	-	30	°C/W
HIS DEVICE PLEA	ESENT	~				

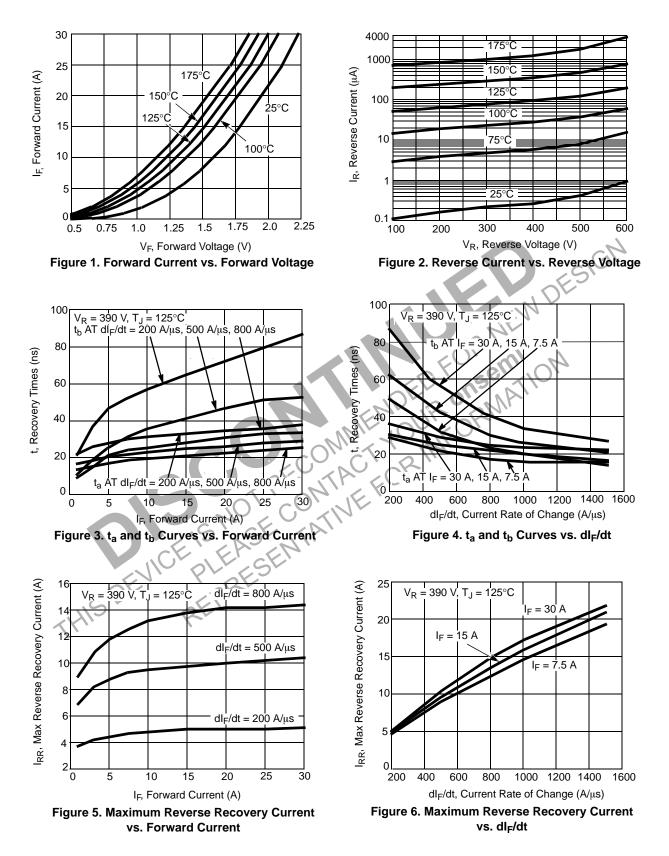
www.onsemi.com 2

ELECTRICAL CHARACTERISTICS (per leg) ($T_C = 25^{\circ}C$ unless otherwise noted)

Parameter	Symbol	Test Conditions		Min	Тур	Max	Unit
OFF STATE CHARACTERISTICS	5			-			
Instantaneous Reverse Current	۱ _R	V _R = 600 V	$T_C = 25^{\circ}C$	_	_	100	μΑ
			T _C = 125°C	-	_	1.0	mA
ON STATE CHARACTERISTICs							
Instantaneous Forward Voltage	V _F	I _F = 15 A	T _C = 25°C	_	1.8	2.2	V
			T _C = 125°C	-	1.65	2.0	V
DYNAMIC CHARACTERISTICS							
Junction Capacitance	CJ	V _R = 10 V, I _F = 0 A		-	62	_	pF
SWITCHING CHARACTERISTIC	S						
Reverse Recovery Time	t _{rr}	$I_F = 1 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, \text{ V}_R = 30 \text{ V}$		_	25	30	ns
		$I_F = 15 \text{ A}, \text{ dl/dt} = 100 \text{ A/}\mu\text{s}, \text{ V}_R = 30 \text{ V}$		-	35	40	ns
Reverse Recovery Time	t _{rr}	$ I_F = 15 \text{ A}, \\ dI_F/dt = 200 \text{ A}/\mu\text{s}, \\ V_R = 390 \text{ V}, \\ T_C = 25^\circ\text{C} $		-	29.4	15	ns
Reverse Recovery Current	I _{rr}			V _R = 390 V,	3.5	<u> </u>	А
Reverse Recovered Charge	Q _{rr}				57	-	nC
Reverse Recovery Time	t _{rr}	$I_{F} = 15 \text{ A}, \\ dI_{F}/dt = 200 \text{ A/}\mu\text{s}, \\ V_{R} = 390 \text{ V}, \\ T_{C} = 125^{\circ}\text{C}$ $I_{F} = 15 \text{ A}, \\ dI_{F}/dt = 800 \text{ A/}\mu\text{s}, \\ V_{R} = 390 \text{ V}, \\ T_{C} = 125^{\circ}\text{C}$		N3.	90	-	ns
Softness Factor (t_b/t_a)	S			NY.	2.0	-	
Reverse Recovery Current	I _{RR}			1	5.0	-	А
Reverse Recovered Charge	Q _{RR}			2-/	275	-	nC
Reverse Recovery Time	t _{rr}			1An	52	-	ns
Softness Factor (t_b/t_a)	S			<u>7.7</u>	1.36	-	
Reverse Recovery Current	I _{RR}			-	13.5	-	А
Reverse Recovered Charge	Q _{RR}			-	390	-	nC
Maximum di/dt during tb	dl _{M/} dt			-	800	_	A/μs

THIS DEVICE PLEASENTATIVES REPRESENTATIVES REPRESENTATIVES

TYPICAL PERFORMANCE CURVES



TYPICAL PERFORMANCE CURVES (continued)

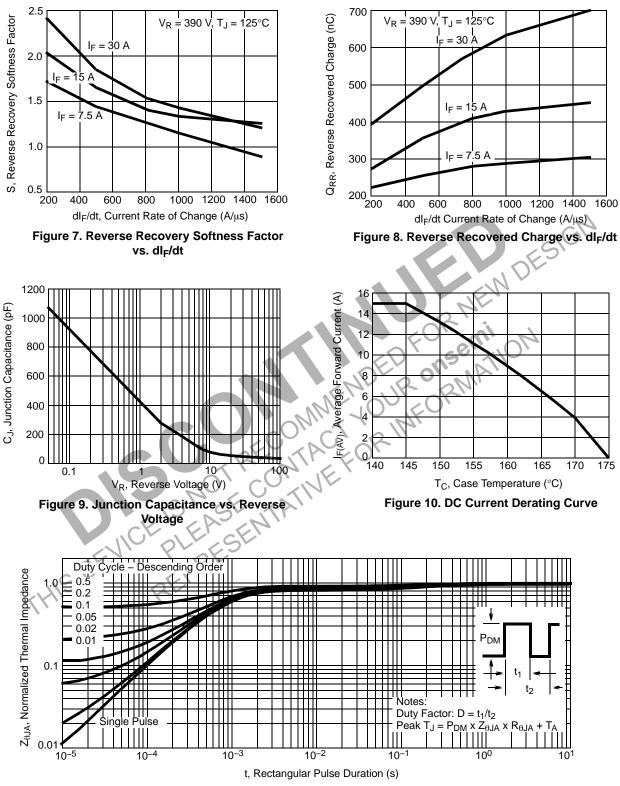
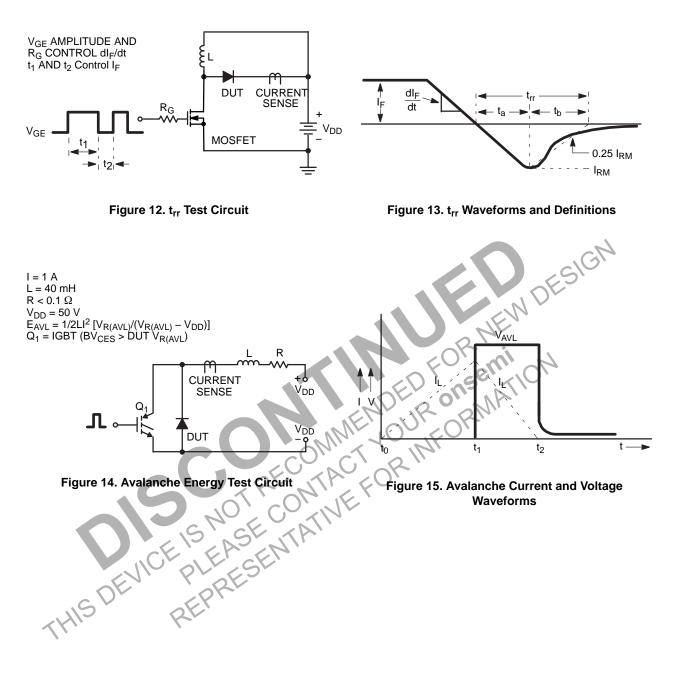


Figure 11. Normalized Maximum Transient Thermal Impedance

TEST CIRCUIT AND WAVEFORMS



STEALTH is a trademark of Semiconductor Components Industries, LLC (SCILLC) or its subsidiaries in the United States and/or other countries.





ON Semiconductor and use trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent_Marking.pdf</u>. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or indental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification. Buyer shall indemnify and hold onsemi and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs,

ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

Technical Library: www.onsemi.com/design/resources/technical-documentation onsemi Website: www.onsemi.com

ONLINE SUPPORT: <u>www.onsemi.com/support</u> For additional information, please contact your local Sales Representative at <u>www.onsemi.com/support/sales</u>